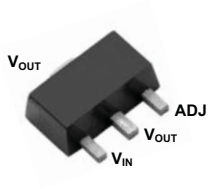
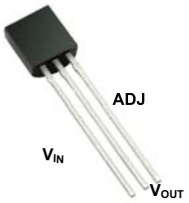
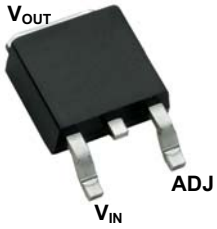
Package Type



TO-243AA (SOT-89)



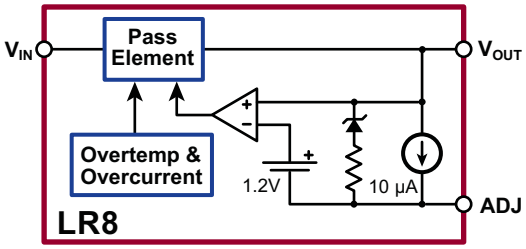
TO-92



TO-252

See Table 2-1 for pin information

Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS†

V_{IN} Input voltage (voltages ref to ADJ)..... -0.5 to +480V
Output voltage range..... 0.5 to +470V
Operating ambient temperature range.....–40°C to +85°C
Operating junction temperature range .....–40°C to +125°C
Storage temperature .....–65°C to +150°C

† Notice: Stresses above those listed under “Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS [1]

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Input to output voltage difference	V_{IN}- V_{OUT}	12		450	V	
Overall output voltage regulation	V_{OUT}	1.14	1.20	1.26	V	13.2V < V_{IN} < 400V, R_1 = 2.4 kΩ, R_2 = 0
		375	400	425	V	R_1 = 2.4 kΩ, R_2 = 782 kΩ
Line regulation	ΔV_{OUT}		0.003	0.01	%/V	17V < V_{IN} < 400V, V_{OUT} = 5V, I_{OUT} = 0.5mA
Load regulation			1.4	3.0	%	V_{IN} = 17V, V_{OUT} = 5V, 0.5 mA < I_{OUT} < 10 mA
Temperature regulation		-1		+1	%	V_{IN} = 17V, V_{OUT} = 5V, I_{OUT} = 10 mA, -40°C < T_A < 85°C
Output current limit	I_{OUT}	10		30	mA	T_J < 85°C, V_{IN} - V_{OUT} = 12V
				0.5	mA	T_J > 125°C, V_{IN} - V_{OUT} = 450V
Minimum output current	I_{OUT}		0.3	0.5	mA	Includes R_1 and load current
Adjust output current	I_{ADJ}	5.0	10	15	µA	
Minimum output load capacitance	C_{LOAD}	1.0			µF	
Ripple rejection ratio	$\Delta V_{OUT}/\Delta V_{IN}$	50	60		dB	120 Hz, V_{OUT} = 5V
Junction temperature limit	T_{LIMIT}	125			°C	

1 Test Conditions unless otherwise specified: -40°C <T_A < 85°C.

TABLE 1-1: TYPICAL THERMAL RESISTANCE

Package	θ_{ja}
TO-252 (D-PAK)	81°C/W
TO-92	132°C/W
TO-243AA (SOT-89)	133°C/W

TABLE 1-2: THERMAL CHARACTERISTICS

Package	Power Dissipation @T_A = 2.5°C	θ_{jc} °C/W	θ_{ja} °C/W
TO-92	0.74W	125	170
TO-243AA (SOT-89)	1.6W	15	78[1]
TO-252 (D-PAK)	2.5W	6.25	50[1]

1 Mounted on FR4 board, 25 mm x 2 mm x 1.57 mm

2.0 PIN DESCRIPTION

The locations of the pins are listed in Package Type.

TABLE 2-1: PIN DESCRIPTION

Function	Description
V_{IN}	Regulator input. 13.2-450V.
V_{OUT}	Regulator output.
ADJ	Output voltage adjust.

3.0 TYPICAL APPLICATION CIRCUITS

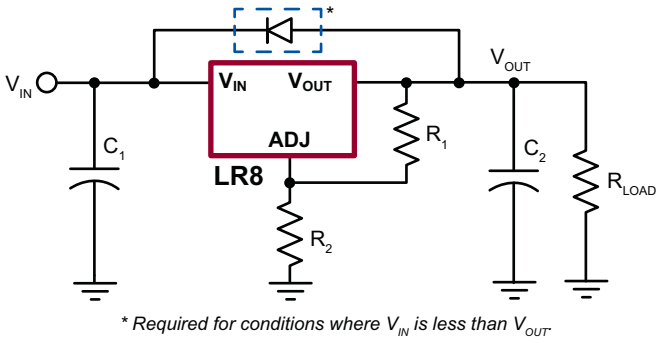


FIGURE 3-1: *Typical Application Circuit.*

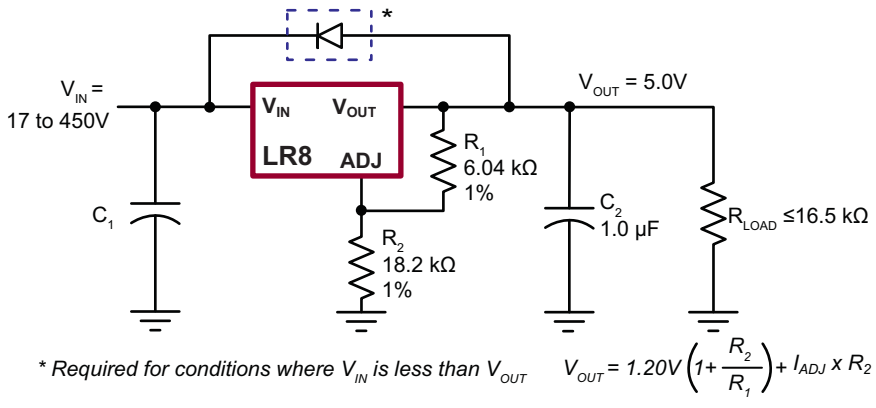


FIGURE 3-2: *High-input Voltage, 5.0V Output Linear Regulator.*

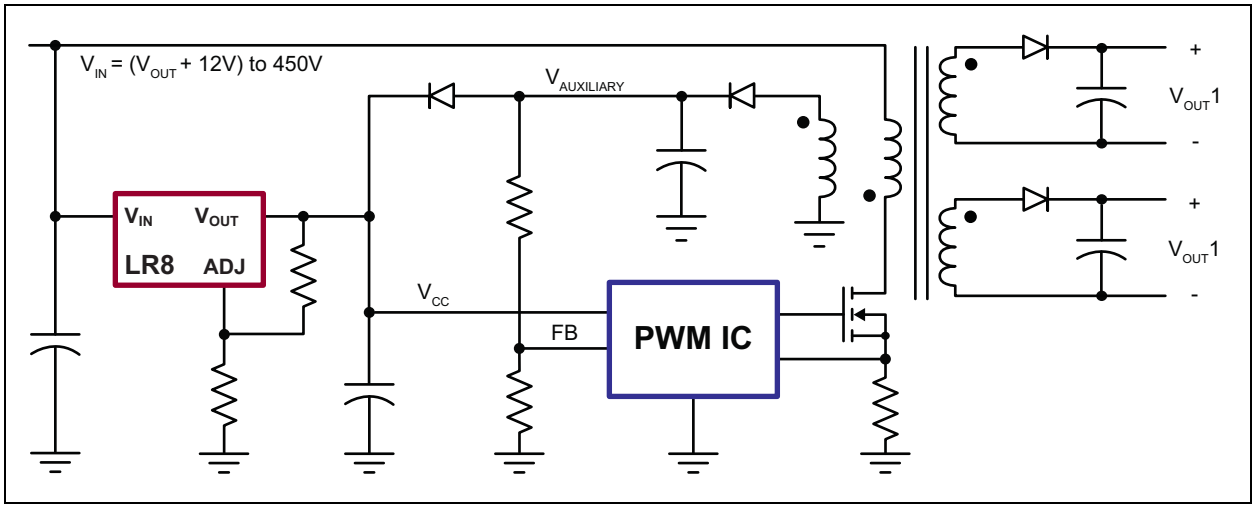


FIGURE 3-3: *SMPS Start-Up Circuit.*

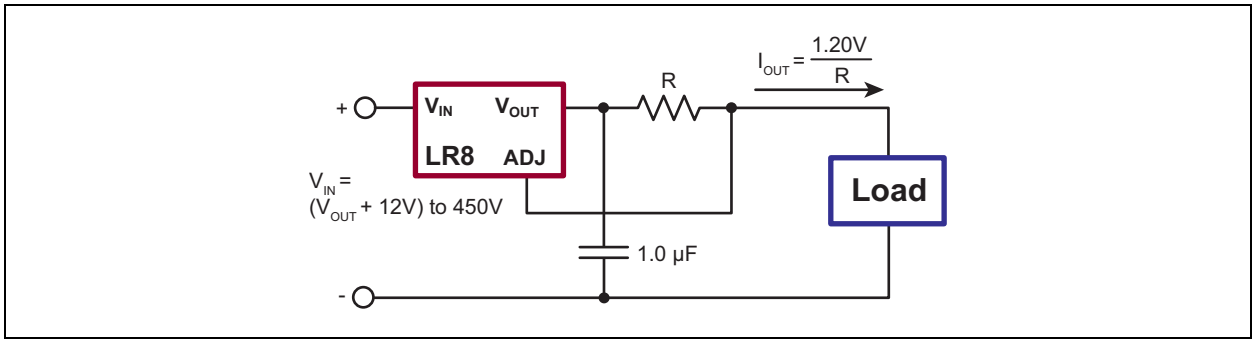


FIGURE 3-4: *High-voltage, Adjustable, Constant-Current Source.*

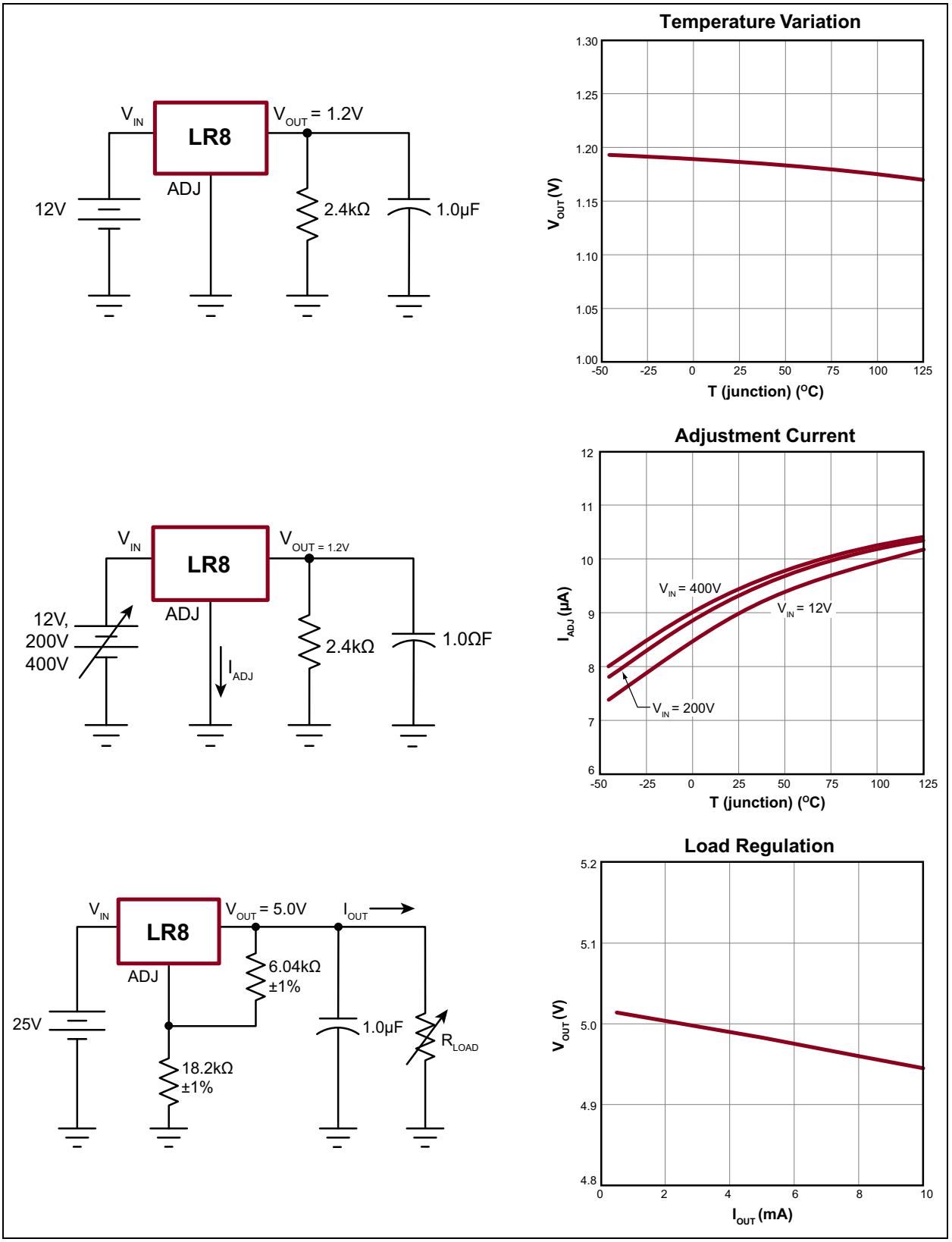


FIGURE 3-5: *Typical Performance Curves 1 of 3.*

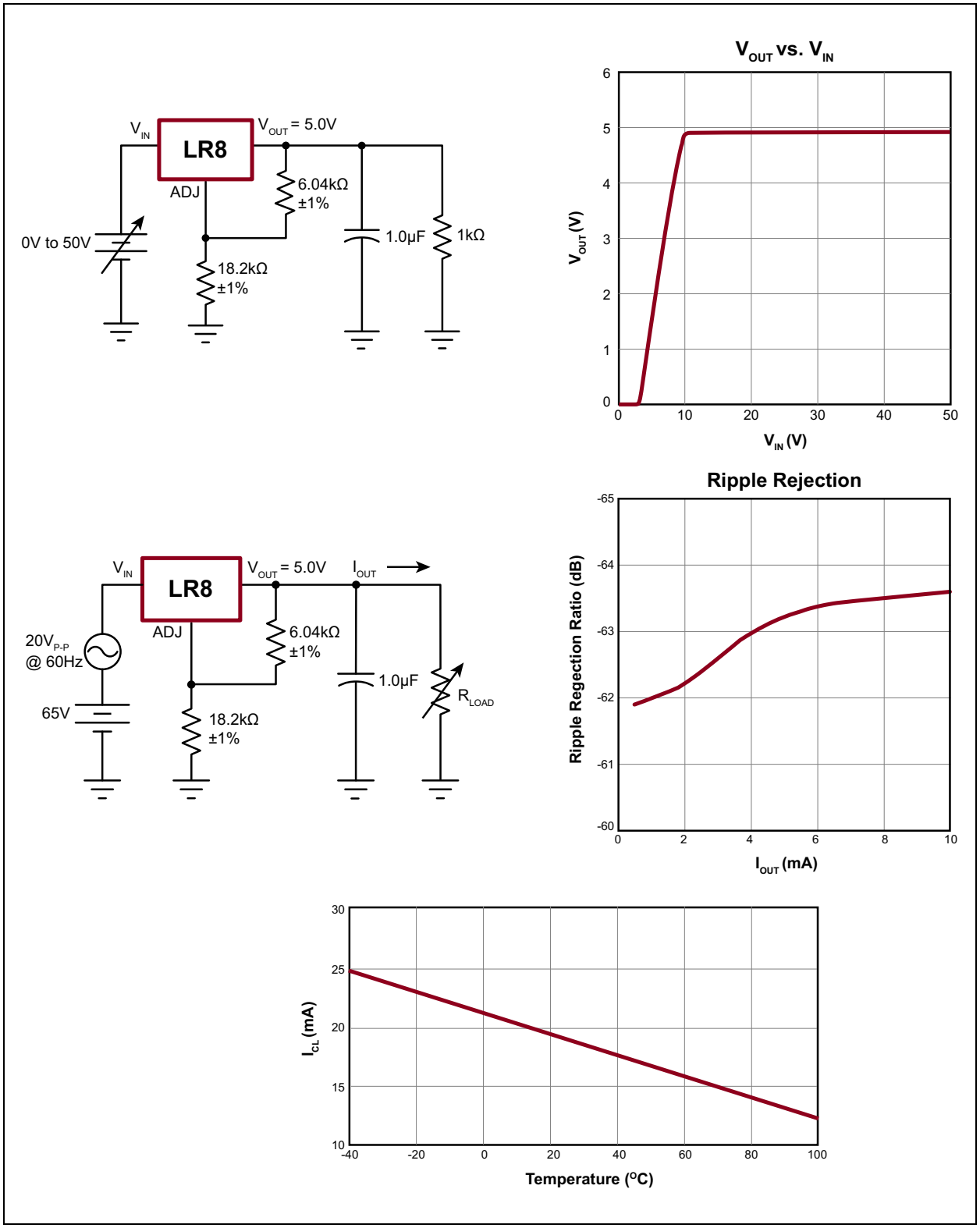


FIGURE 3-6: *Typical Performance Curves 2 of 3.*

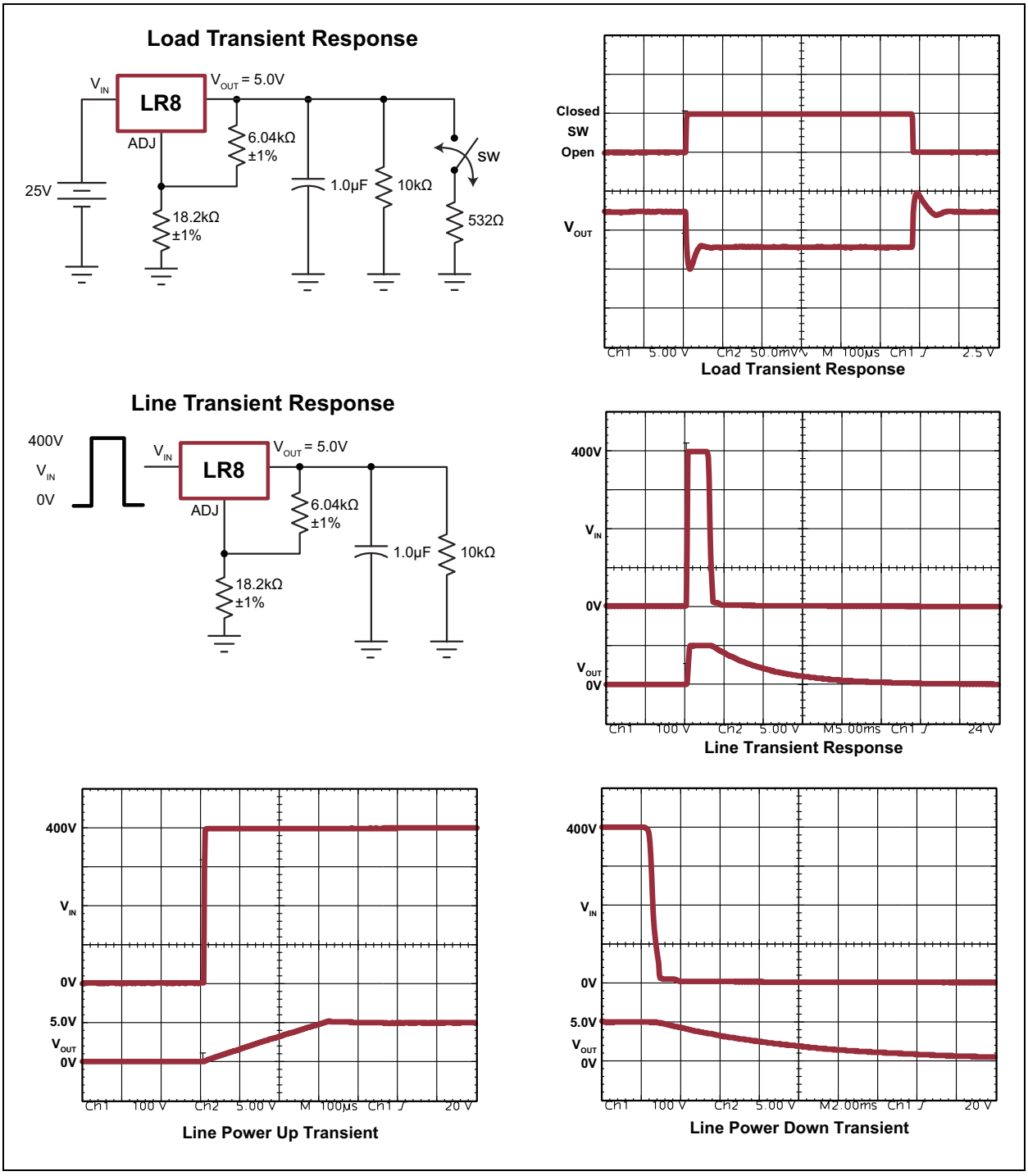
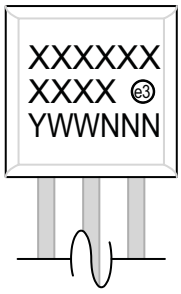


FIGURE 3-7: *Typical Performance Curves 3 of 3.*

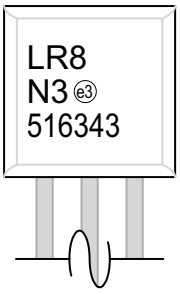
4.0 PACKAGING INFORMATION

4.1 Package Marking Information

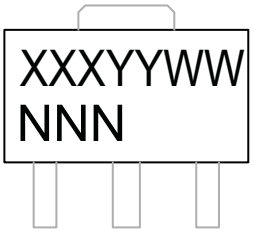
3-lead TO-92



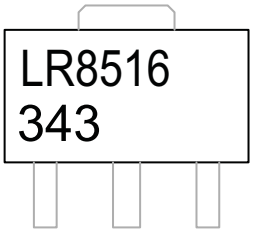
Example



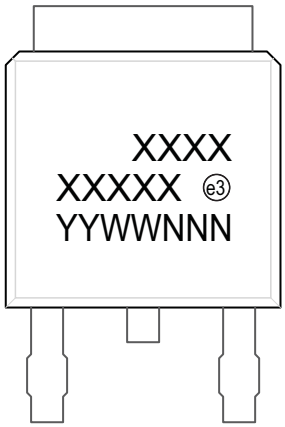
3-lead TO-243AA * (SOT-89)



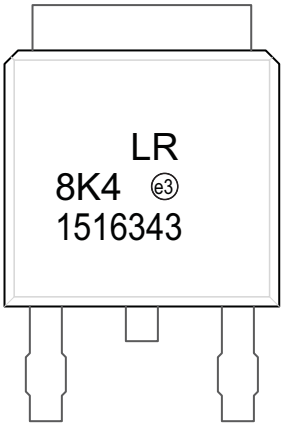
Example



3-lead TO-252 (D-PAK)



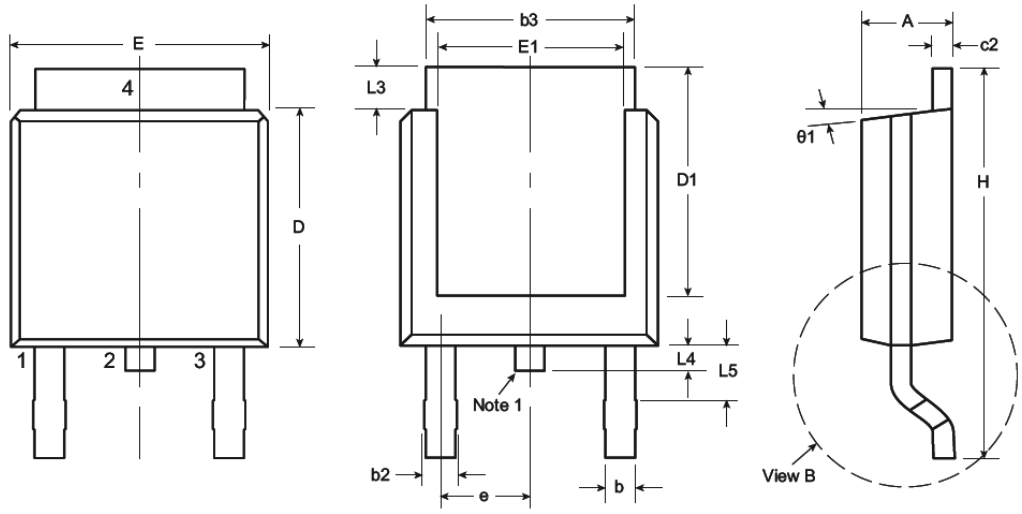
Example



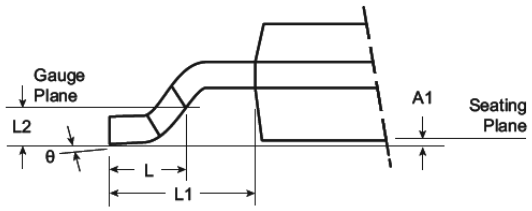
Legend:	XX...X	Product Code or Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

3-Lead TO-252 (D-PAK) Package Outline (K4)



Front View **Rear View** **Side View**



View B

Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

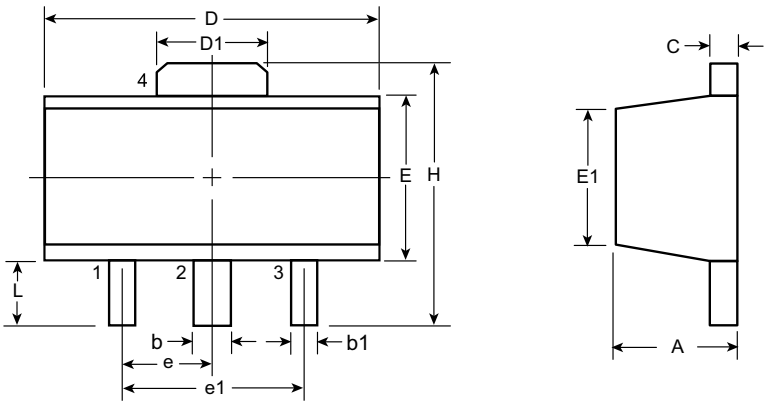
Note:

1. Although 4 terminal locations are shown, only 3 are functional. Lead number 2 was removed.

Symbol		A	A1	b	b2	b3	c2	D	D1	E	E1	e	H	L	L1	L2	L3	L4	L5	θ	θ1
Dimension (inches)	MIN	.086	.000*	.025	.030	.195	.018	.235	.205	.250	.170	.090 BSC	.370	.055	.108 REF	.020 BSC	.035	.025*	.035†	0º	0º
	NOM	-	-	-	-	-	-	.240	-	-	-		-	.060			-	-	-	-	-
	MAX	.094	.005	.035	.045	.215	.035	.245	.217*	.265	.200*		.410	.070			.050	.040	.060	10º	15º

JEDEC Registration TO-252, Variation AA, Issue E, June 2004.
** This dimension is not specified in the JEDEC drawing.*
† This dimension differs from the JEDEC drawing.
Drawings not to scale.

3-Lead TO-243AA (SOT-89) Package Outline (N8)



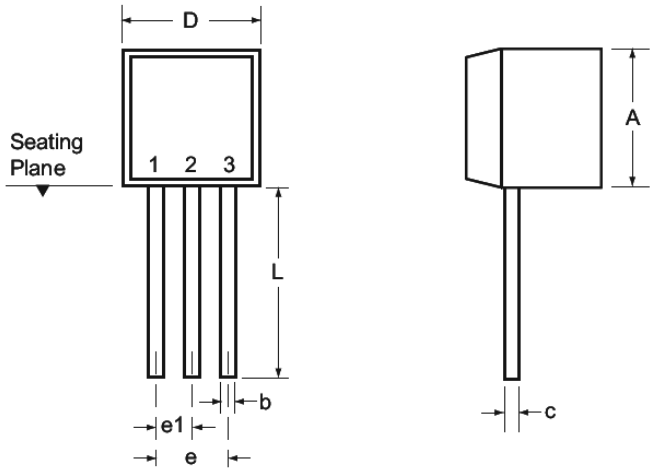
Top View **Side View**

Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

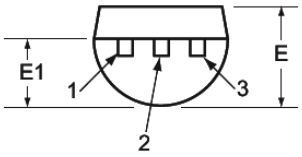
Symbol		A	b	b1	C	D	D1	E	E1	e	e1	H	L
Dimensions (mm)	MIN	1.40	0.44	0.36	0.35	4.40	1.62	2.29	2.00†	1.50 BSC	3.00 BSC	3.94	0.73†
	NOM	-	-	-	-	-	-	-	-			-	-
	MAX	1.60	0.56	0.48	0.44	4.60	1.83	2.60	2.29			4.25	1.20

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.
***†** This dimension differs from the JEDEC drawing*
***Drawings not to scale**.*

3-Lead TO-92 Package Outline (L/LL/N3)



Front View **Side View**



Bottom View

Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Symbol		A	b	c	D	E	E1	e	e1	L
Dimensions (inches)	MIN	.170	.014†	.014†	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022†	.022†	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.
** This dimension is not specified in the JEDEC drawing.*
† This dimension differs from the JEDEC drawing.
Drawings not to scale.

NOTES:

APPENDIX A: REVISION HISTORY

Revision B (November 2017)

The following is the list of modifications:

1. Updated Figure 3-2.
2. Various typographical edits.

Revision A (June 2015)

- Original Release of this Document.

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	XX	-	X	-	X
Device	Package Options		Environmental		Media Type

Device:	LR8	= High-Input Voltage, Adjustable, 3-Terminal, Linear Regulator
Package:	N3	= TO-92
	K4	= TO-252 (D-PAK)
	N8	= TO-243AA (SOT-89)
Environmental	G	= Lead (Pb)-free/ROHS-compliant package
Media Type:	(blank)	= 1000/Bag for N3 packages
		= 2000/Reel for K4 packages
		= 2000/Reel for N8 packages
	P003	= 2000/Reel for N3 package

Examples:

a)	LR8N3-G	TO-92 package, 1000/bag
b)	LR8N3-G-P003:	TO-92 package, 2000/reel.
c)	LR8K4-G	TO-252 package, 2000/reel
d)	LR8N8-G	TO-243AA package, 2000/reel

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